

Very Low Power 2-Output PCIe Clock Buffer

Features

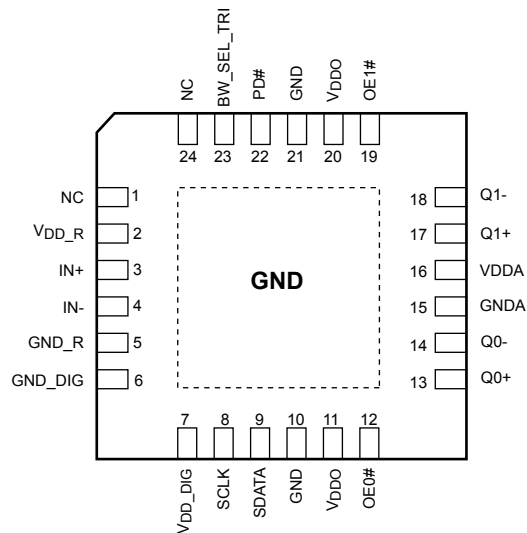
- 1.8V supply voltage
- HCSL input: 100MHz, also support 50MHz or 125MHz via SMBus
- 2 differential low power HCSL outputs
- Individual output enable
- Programmable Slew rate and output amplitude for each output
- Differential outputs blocked until PLL is locked
- Strapping pins or SMBus for configuration;
- 3.3V tolerant SMBus interface support
- Very low jitter outputs
 - Differential cycle-to-cycle jitter <50ps
 - Differential output-to-output skew <50ps
 - PCIe Gen1/Gen2/Gen3/ Gen4 compliant
- Packaging (Pb-free & Green): |
24-lead 4×4mm TQFN

Description

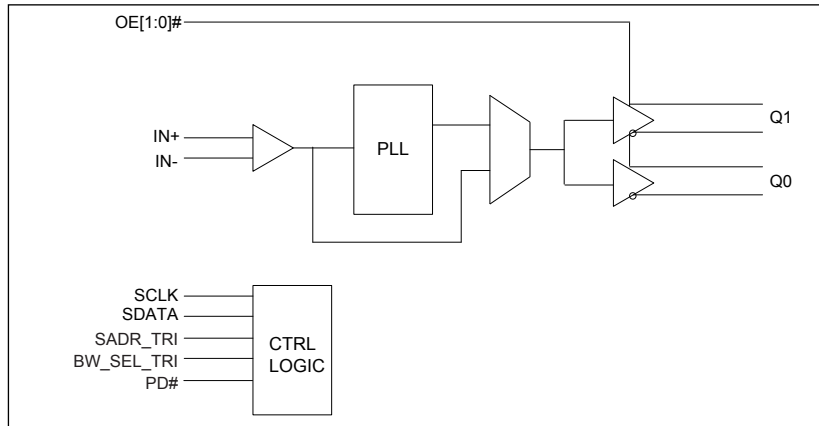
The PI6CB18200 is an 2-output very low power PCIe Gen1/ Gen2/Gen3/ Gen4 clock buffer. It takes an reference input to fanout two 100MHz low power differential HCSL outputs. Individual OE pin for each output provides easier power management.

It uses Diodes proprietary PLL design to achieve very low jitter that meets PCIe Gen1/Gen2/Gen3 requirements. Other than PCIe 100MHz support, this device also support Ethernet application with 50MHz or 125MHz via SMBus. It provides various options such as different slew rate and amplitude through strapping pins or SMBUS so that users can configure the device easily to get the optimized performance for their individual boards.

Pin Configuration



Block Diagram



Pin Description

| Pin Number | Pin Name | Type | | Description |
|------------|---------------------|------------------|-----------|---|
| 1, 24 | NC | | | Internal connected for feedback loop. Do not connect this pin |
| 2 | V _{DD_R} | Power | | Power supply for input differential buffers |
| 3 | IN+ | Input | | Differential true clock input |
| 4 | IN- | Input | | Differential complementary clock input |
| 5 | GND _R | Power | | Ground for input differential buffers |
| 6 | GND _{DIG} | Power | | Ground for digital circuitry |
| 7 | V _{DD_DIG} | Power | | Power supply for digital circuitry, nominal 1.8V |
| 8 | SCLK | Input | CMOS | SMBUS clock input, 3.3V tolerant |
| 9 | SDATA | Input/ Output | CMOS | SMBUS Data line, 3.3V tolerant |
| 10, 21 | GND | Power | | Ground |
| 11, 20 | V _{DDO} | Power | | Power supply for differential outputs |
| 12 | OE0# | Input | CMOS | Active low input for enabling Q0 pair. This pin has an internal pull-down. 1 =disable outputs, 0 = enable outputs |
| 13 | Q0+ | Output | HCSL | Differential true clock output |
| 14 | Q0- | Output | HCSL | Differential complementary clock output |
| 15 | GND _A | Power | | Ground for analog circuitry |
| 16 | V _{DDA} | Power | | Power supply for analog circuitry |
| 17 | Q1+ | Output | HCSL | Differential true clock output |
| 18 | Q1- | Output | HCSL | Differential complementary clock output |
| 19 | OE1# | Input | CMOS | Active low input for enabling Q1 pair. This pin has an internal pull-down. 1 =disable outputs, 0 = enable outputs |
| 22 | PD# | Input | CMOS | Input notifies device to sample latched inputs and start up on first high assertion. Low enters Power Down Mode, subsequent high assertions exit Power Down Mode. This pin has internal pull-up resistor. |
| 23 | BW_SEL_TRI | Input | Tri-level | Latch to select low loop bandwidth, bypass PLL, and high loop bandwidth. This pin has both internal pull-up and pull-down |

Power Management Table

| PD# | IN | SMBus OE bit | OEn# | Qn+ | Qn- | PLL Status |
|-----|---------|--------------|------|---------|---------|-----------------|
| 0 | X | X | X | Low | Low | Off |
| 1 | Running | 0 | X | Low | Low | On ¹ |
| 1 | Running | 1 | 0 | Running | Running | On ¹ |
| 1 | Running | 1 | 1 | Low | Low | On ¹ |

Note:

1. If PLL Bypass mode is selected, the PLL will be off and outputs will be running.

PLL Operating Mode Select Table

| BW_SEL_TRI | Operating Mode | Byte1 [7:6] Readback | Byte1 [4:3] Readback |
|------------|-------------------------|----------------------|----------------------|
| 0 | PLL with low Bandwidth | 00 | 00 |
| M | PLL Bypass | 01 | 01 |
| 1 | PLL with high Bandwidth | 11 | 11 |

Frequency Select table

| Freq. Select Byte 3 [4:3] | IN (MHz) | Qn (MHz) |
|---------------------------|----------|----------|
| 00 (default) | 100 | 100 |
| 01 | 50 | 50 |
| 10 | 125 | 125 |
| 11 | Reserved | Reserved |

Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

| | |
|--|--|
| Storage Temperature..... | -65°C to +150°C |
| Junction Temperature | up to +125°C |
| Supply Voltage to Ground Potential, V_{DDxx} | -0.5V to +2.5V |
| Input Voltage | -0.5V to $V_{DD}+0.5V$, not exceed 2.5V |
| SMBus, Input High Voltage | 3.6V |
| ESD Protection (HBM) | 2000 V |

Note: Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Operating Conditions

Temperature = T_A ; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min.. | Typ. | Max. | Units |
|---|---|--|-------|------|------|-------|
| $V_{DD}, V_{DDA}, V_{DD_R}, V_{DD_DIG}$ | Power Supply Voltage | | 1.7 | 1.8 | 1.9 | V |
| V_{DDO} | Output Power Supply Voltage | | 1.7 | 1.8 | 1.9 | V |
| I_{DDA} | Analog Power Supply Current | $V_{DDA} + V_{DD_R}$, PLL mode, All outputs active @100MHz | | 4.5 | 6 | mA |
| I_{DD} | Power Supply Current | $V_{DD} + V_{DD_DIG}$, All outputs active @100MHz | | 8 | 10 | mA |
| I_{DDO} | Power Supply Current for Outputs | All outputs active @100MHz | | 6 | 8 | mA |
| I_{DDA_PD} | Analog Power Supply Power Down ¹ Current | $V_{DDA} + V_{DD_R}$, PLL mode, All outputs active @100MHz | | 0.7 | 1 | mA |
| I_{DD_PD} | Power Supply Power Down ¹ Current | $V_{DD} + V_{DD_DIG} + V_{DDO}$, All outputs LOW/LOW | | | 1.4 | mA |
| T_A | Ambient Temperature | Industrial grade | -40 | | 85 | °C |

Note:

1. Input clock is not running.

Input Electrical Characteristics

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
|-----------|-------------------------------|------------|------|------|------|------------|
| R_{pu} | Internal pull up resistance | | | 120 | | K Ω |
| R_{dn} | Internal pull down resistance | | | 120 | | K Ω |
| L_{PIN} | Pin inductance | | | | 7 | nH |

SMBus Electrical Characteristics

Temperature = T_A ; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
|---------------|---------------------------|--|---------------------|------|------|-------|
| V_{DDSMB} | Nominal bus voltage | | 1.7 | | 3.6 | V |
| V_{IHSMB} | SMBus Input High Voltage | SMBus, $V_{DDSMB} = 3.3V$ | 2.1 | | 3.6 | V |
| | | SMBus, $V_{DDSMB} < 3.3V$ | 0.65 V_{DDSMB} | | | |
| V_{ILSMB} | SMBus Input Low Voltage | SMBus, $V_{DDSMB} = 3.3V$ | | | 0.6 | V |
| | | SMBus, $V_{DDSMB} < 3.3V$ | | | 0.6 | |
| $I_{SMBSINK}$ | SMBus sink current | SMBus, at V_{OLSMB} | 4 | | | mA |
| V_{OLSMB} | SMBus Output Low Voltage | SMBus, at $I_{SMBSINK}$ | | | 0.4 | V |
| f_{MAXSMB} | SMBus operating frequency | Maximum frequency | | | 400 | kHz |
| t_{RMSB} | SMBus rise time | (Max $V_{IL} - 0.15$) to (Min $V_{IH} + 0.15$) | | | 1000 | ns |
| t_{FMSB} | SMBus fall time | (Min $V_{IH} + 0.15$) to (Max $V_{IL} - 0.15$) | | | 300 | ns |

LVC MOS DC Electrical Characteristics

Temperature = T_A ; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
|----------|--------------------|--|------------------|--------------|------------------|---------|
| V_{IH} | Input High Voltage | Single-ended inputs, except SMBus | 0.75 V_{DD} | | V_{DD} +0.3 | V |
| V_{IM} | Input Mid Voltage | BW_SEL_TRI | 0.4 V_{DD} | 0.5 V_{DD} | 0.6 V_{DD} | V |
| V_{IL} | Input Low Voltage | Single-ended inputs, except SMBus | -0.3 | | 0.25 V_{DD} | V |
| I_{IH} | Input High Current | Single-ended inputs, $V_{IN} = V_{DD}$ | | | 20 | μA |
| I_{IL} | Input Low Current | Single-ended inputs, $V_{IN} = 0V$ | -20 | | | μA |
| I_{IH} | Input High Current | Single-ended inputs with pull up / pull down resistor, $V_{IN} = V_{DD}$ | | | 220 | μA |
| I_{IL} | Input Low Current | Single-ended inputs with pull up / pull down resistor, $V_{IN} = 0V$ | -220 | | | μA |
| C_{IN} | Input Capacitance | | 1.5 | | 5 | pF |

LVCMOS AC Electrical Characteristics

Temperature = T_A; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
|---------------------|-----------------------|---|------|------|------|--------|
| t _{OE} LAT | Output enable latency | Q start after OE# assertion Q stop after OE# deassertion | 1 | | 3 | clocks |
| t _{PD} LAT | PD# de-assertion | Differential outputs enable after PD# de-assertion | | 20 | 300 | us |

HCSL Input Characteristics ¹

Temperature = T_A; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Conditions | Min. | Typ. | Max. | Units |
|--------------------|---------------------------------------|---|------|------|-------|-------|
| V _{IHDIF} | Diff. Input High Voltage ³ | IN+, IN-, single-end measurement | 600 | 800 | 1150 | mV |
| V _{ILDIF} | Diff. Input Low Voltage ³ | IN+, IN-, single-end measurement | -300 | 0 | 300 | mV |
| V _{COM} | Diff. Input Common Mode Voltage | | 150 | | 1000 | mV |
| V _{SWING} | Diff. Input Swing Voltage | Peak to peak value (V _{IHDIF} - V _{ILDIF}) | 300 | | 1450 | mV |
| f _{INBP} | Input Frequency | PLL Bypass mode | 1 | | 200 | MHz |
| f _{IN100} | Input Frequency | 100MHz PLL | 60 | 100 | 110 | MHz |
| f _{IN125} | Input Frequency | 125MHz PLL | 75 | 125 | 137.5 | MHz |
| f _{IN156} | Input Frequency | 50MHz PLL | 30 | 50 | 65 | MHz |
| t _{STAB} | Clock stabilization | From V _{DD} Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock | | 0.6 | 1.0 | ms |
| t _{RF} | Diff. Input Slew Rate ² | Measured differentially | 0.4 | | | V/ns |
| I _{IN} | Diff. Input Leakage Current | V _{IN} = V _{DD} , V _{IN} = GND | -5 | 0.01 | 5 | uA |
| t _{DC} | Diff. Input Duty Cycle | Measured differentially | 45 | | 55 | % |
| t _{jC-c} | Diff. Input Cycle to cycle jitter | Measured differentially | | | 125 | ps |

Note:

1. Guaranteed by design and characterization, not 100% tested in production
2. Slew rate measured through +/-75mV window centered around differential zero
3. The device can be driven by a single-ended clock by driving the true clock and biasing the complement clock input to the V_{bias}, where V_{bias} is (V_{IH}-V_{IL})/2

HCSL Output Characteristics

Temperature = T_A ; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Condition | Min. | Typ. | Max. | Units |
|--------------|--|---|------|------|------|-------|
| V_{OH} | Output Voltage High ¹ | Statistical measurement on single-ended signal using oscilloscope math function | 660 | 774 | 900 | mV |
| V_{OL} | Output Voltage Low ¹ | | -150 | | 150 | mV |
| V_{OMAX} | Output Voltage Maximum ¹ | Measurement on single ended signal using absolute value | | 821 | 1150 | mV |
| V_{OMIN} | Output Voltage Minimum ¹ | | -300 | -15 | | mV |
| V_{OSWING} | Output Swing Voltage ^{1,2,3} | Scope averaging off | 300 | 1536 | | mV |
| V_{OC} | Output Cross Voltage ^{1,2,4} | | 250 | 430 | 550 | mV |
| DV_{OC} | V_{OC} Magnitude Change ^{1,2,5} | | | 12 | 140 | mV |

Note:

1. At default SMBUS amplitude settings
2. Guaranteed by design and characterization, not 100% tested in production
3. Measured from differential waveform
4. This one is defined as voltage where $Q+ = Q-$ measured on a component test board and only applied to the differential rising edge
5. The total variation of all V_{cross} measurements in any particular system. This is a subset of $V_{cross_min/max}$ allowed.

HCSL Output AC Characteristics

Temperature = T_A ; Supply voltages per normal operation conditions; See test circuits for the load conditions

| Symbol | Parameters | Condition | Min. | Typ. | Max. | Units |
|--------------|--|--|------|------|------|-------|
| f_{OUT} | Output Frequency | | | 100 | | MHz |
| BW | PLL bandwidth ^{1,8} | -3dB point in High Bandwidth Mode | 2 | 2.7 | 4 | MHz |
| | | -3dB point in Low Bandwidth Mode | 1 | 1.4 | 2 | MHz |
| t_{jpeak} | PLL Jitter Peaking | Peak pass band gain | | 1.2 | 2 | dB |
| t_{RF} | Slew rate ^{1,2,3} | Scope averaging on fast setting | 2.2 | 3.0 | 6 | V/ns |
| | | Scope averaging on slow setting | 0.4 | 2 | 3 | V/ns |
| D_{tRF} | Slew rate matching ^{1,2,4} | Scope averaging on | | 7 | 20 | % |
| t_{SKEW} | Output Skew ^{1,2} | Averaging on, $V_T = 50\%$ | | 43 | 50 | ps |
| t_{PDELAY} | Propagation delay | PLL Bypass mode, $V_T = 50\%$ | 2800 | 3600 | 4500 | ps |
| | | PLL mode, $V_T = 50\%$ | 0 | 90 | 200 | ps |
| t_{j-c-c} | Cycle to cycle jitter ^{1,2} | | | 14 | 50 | ps |
| t_{jPHASE} | Integrated phase jitter (RMS) ^{1,5,6} | PCIe Gen 1 | 20 | 22 | 86 | ps |
| | | PCIe Gen 2 Low Band, $10kHz < f < 1.5MHz$ | 0.2 | 0.3 | 3.0 | ps |
| | | PCIe Gen 2 High Band, $1.5MHz < f < Nyquist (50MHz)$ | 1.6 | 2.0 | 3.1 | ps |
| | | PCIe Gen 3 (PLL BW of 2-4 or 2-5MHz, CDR =10MHz) | 0.3 | 0.35 | 1.0 | ps |
| | | 125MHz, 1.5MHz to 20MHz, -20dB/decade Rollover < 1.5MHz, -40dB/decade rolloff > 10MHz ⁹ | | 1.9 | 2 | ps |

HC SL Output AC Characteristics (continued)

| Symbol | Parameters | Condition | Min. | Typ. | Max. | Units |
|----------------------|--|---|------|------|------|-------|
| t _{JPHASEA} | Additive Integrated phase jitter (RMS) ^{1,5,10} | PCIe Gen 1 | | 0.6 | 5 | ps |
| | | PCIe Gen 2 Low Band, 10kHz < f < 1.5MHz | | 0.1 | 0.3 | ps |
| | | PCIe Gen 2 High Band, 1.5MHz < f < Nyquist (50MHz) | | 0.05 | 0.1 | ps |
| | | PCIe Gen 3 (PLL BW of 2-4 or 2-5MHz, CDR =10MHz) | | 0.05 | 0.1 | ps |
| | | PCIe Gen 4 (PLL BW of 2-4 or 2-5MHz, CDR =10MHz) (BW_SEL_TRI=M) | | 0.03 | 0.05 | ps |
| | | 125MHz, 1.5MHz to 20MHz, -20dB/decade Rollover < 1.5MHz, -40dB/decade rolloff > 10MHz | | 0.15 | 0.3 | ps |
| t _{DC} | Duty Cycle ^{1,2} | Measured differentially, PLL Mode | 45 | 50 | 55 | % |
| t _{DCCD} | Duty Cycle Distortion ^{1,7} | Measured differentially, PLL Bypass Mode at 100MHz | -1 | 0 | 1 | % |
| t _{STARTUP} | Start up time | | | | 10 | ms |
| t _{LOCK} | PLL lock time | | | | 20 | ms |

Note:

1. Guaranteed by design and characterization, not 100% tested in production
2. Measured from differential waveform
3. Slew rate is measured through the Vswing voltage range centered around differential 0V, within +/-150mV window
4. Slew rate matching is measured using a +/-75mV window centered on differential zero
5. See <http://www.pcisig.com> for complete specs
6. Sample size of at least 100k cycles. This can be extrapolated to 108ps pk-pk @ 1M cycles for a BER of 10⁻¹²
7. Duty cycle distortion is the difference in duty cycle between the out and input clock when the device is operated in the PLL bypass mode
8. The Min and Max values of each BW setting track each other, low BW max will never occur with high BW min
9. Applies to all differential outputs
10. For additive jitter RMS value is calculated by the following equation = SQRT [(total jitter)² - (input jitter)²]

SMBus Serial Data Interface

PI6CB18200 is a slave only device that supports block read and block write protocol using a single 7-bit address and read/write bit as shown below.

Read and write block transfers can be stopped after any complete byte transfer.

Address Assignment

| A6 | A5 | A4 | A3 | A2 | A1 | A0 | R/W |
|----|----|----|----|------------------------------------|----|----|-----|
| 1 | 1 | 0 | 1 | See SBMbus Address Selection table | | | 1/0 |

Note: SMBus address is latched on SADR pin

How to Write

| 1 bit | 7 bits | 1 bit | 1 bit | 8 bits | 1 bit | 8 bits | 1 bit | 8 bits | 1 bit | | 8 bits | 1 bit | 1 bit |
|-----------|--------|-------|-------|-----------------------------|-------|---------------------|-------|-------------------------|-------|-------|-------------------|-------|----------|
| Start bit | Add. | W(0) | Ack | Beginning Byte location = N | Ack | Data Byte count = X | Ack | Beginning Data Byte (N) | Ack | | Data Byte (N+X-1) | Ack | Stop bit |

How to Read

| 1 bit | 7 bits | 1 bit | 1 bit | 8 bits | 1 bit | 1 bit | 7 bits | 1 bit | 1 bit | 8 bits | 1 bit | 8 bits | 1 bit |
|-----------|---------|-------|-------|-----------------------------|-------|------------------|---------|-------|-------|---------------------|-------|-------------------------|-------|
| Start bit | Address | W(0) | Ack | Beginning Byte location = N | Ack | Repeat Start bit | Address | R(1) | Ack | Data Byte count = X | Ack | Beginning Data Byte (N) | Ack |

| | | | | | | | | | | | 8 bits | 1 bit | 1 bit |
|-------|--|--|--|--|--|--|--|--|--|--|-------------------|-------|----------|
| | | | | | | | | | | | Data Byte (N+X-1) | NAck | Stop bit |

Byte 0: Output Enable Register ¹

| Bit | Control Function | Description | Type | Power Up Condition | 0 | 1 |
|-----|------------------|------------------|------|--------------------|---------|---------|
| 7 | Reserved | | | 1 | | |
| 6 | Reserved | | | 1 | | |
| 5 | Q1_OE | Q1 output enable | RW | 1 | Low/Low | Enabled |
| 4 | Reserved | | | 1 | | |
| 3 | Q0_OE | Q0 output enable | RW | 1 | Low/Low | Enabled |
| 2 | Reserved | | | 1 | | |
| 1 | Reserved | | | 1 | | |
| 0 | Reserved | | | 1 | | |

Note:

1. A low on these bits will override the OE# pins and force the differential outputs to Low/Low states

Byte 1: PLL Operating Mode and Output Amplitude Control Register

| Bit | Control Function | Description | Type | Power Up Condition | 0 | 1 |
|-----|------------------|-------------------------------|-----------------|--------------------|--|--------------------------------|
| 7 | PLLMODERB1 | PLL Mode Readback Bit1 | R | Latch | See PLL Operating Mode Table | |
| 6 | PLLMODERB0 | PLL Mode Readback Bit0 | R | Latch | | |
| 5 | PLLMODE_SWCTR | Enable SW control of PLL Mode | RW | 0 | Values in B1[7:6] set PLL Mode | Values in B1[4:3] set PLL Mode |
| 4 | PLLMODE1 | PLL Mode control Bit1 | RW ¹ | 0 | See PLL Operating Mode Table | |
| 3 | PLLMODE0 | PLL Mode control Bit0 | RW ¹ | 0 | | |
| 2 | Reserved | | | 1 | | |
| 1 | Amplitude1 | Control output amplitude | RW | 1 | '00' = 0.6V, '01' = 0.7V, '10' = 0.8V, '11' = 0.9V | |
| 0 | Amplitude0 | | RW | 0 | | |

Note:

1. B1[5] must be set to a 1 for these bits to have any effect on the part

Byte 2: Differential Output Slew Rate Control Register

| Bit | Control Function | Description | Type | Power Up Condition | 0 | 1 |
|-----|------------------|-------------------------|------|--------------------|--------------|--------------|
| 7 | Reserved | | | 1 | | |
| 6 | Reserved | | | 1 | | |
| 5 | SLEWRATECTR_Q1 | Control slew rate of Q1 | RW | 1 | Slow setting | Fast setting |
| 4 | Reserved | | | 1 | | |
| 3 | SLEWRATECTR_Q0 | Control slew rate of Q0 | RW | 1 | Slow setting | Fast setting |
| 2 | Reserved | | | 1 | | |
| 1 | Reserved | | | 1 | | |
| 0 | Reserved | | | 1 | | |

Byte 3: Frequency Select Control Register

| Bit | Control Function | Description | Type | Power Up Condition | 0 | 1 |
|-----|------------------|-------------------------------------|-----------------|--------------------|-----------------------------|----------------------------|
| 7 | Reserved | | | 1 | | |
| 6 | Reserved | | | 1 | | |
| 5 | FREQ_SEL_EN | Enable SW selection of frequency | RW | 0 | SW Freq. selection disabled | SW Freq. selection enabled |
| 4 | FSEL1 | Freq. Select Bit 1 | RW ¹ | 0 | See Frequency Select Table | |
| 3 | FSEL0 | Freq. Select Bit 0 | RW ¹ | 0 | | |
| 2 | Reserved | | | 1 | | |
| 1 | Reserved | | | 1 | | |
| 0 | SLEWRATESEL_FB | Adjust Slew Rate of Feedback signal | RW | 1 | 2.0V/ns | 3.0V/ns |

Note:

1. B1[5] must be set to a 1 for these bits to have any effect on the part

Byte 4: Reserved

| Bit | Control Function | Description | Type | Power Up Condition | 0 | 1 |
|-----|------------------|-------------|------|--------------------|---|---|
| 7:0 | Reserved | | | 1 | | |

Byte 5: Revision and Vendor ID Register

| Bit | Control Function | Description | Type | Power Up Condition | 0 | 1 |
|-----|------------------|-------------|------|--------------------|---------------|---|
| 7 | RID3 | Revision ID | R | 0 | rev = 0000 | |
| 6 | RID2 | | R | 0 | | |
| 5 | RID1 | | R | 0 | | |
| 4 | RID0 | | R | 0 | | |
| 3 | PVID3 | Vendor ID | R | 0 | Diodes = 0011 | |
| 2 | PVID3 | | R | 0 | | |
| 1 | PVID3 | | R | 1 | | |
| 0 | PVID3 | | R | 1 | | |

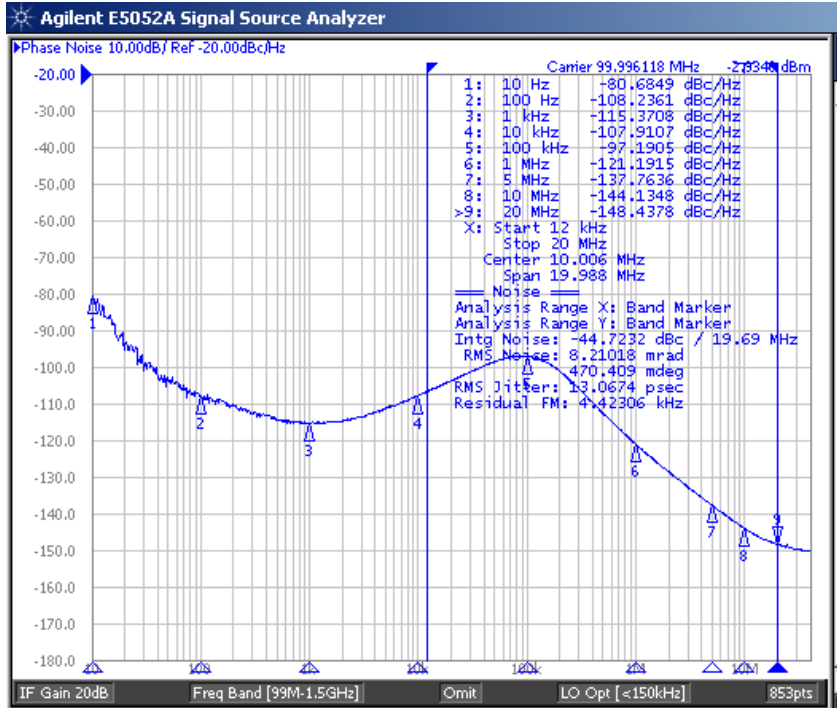
Byte 6: Device Type/Device ID Register

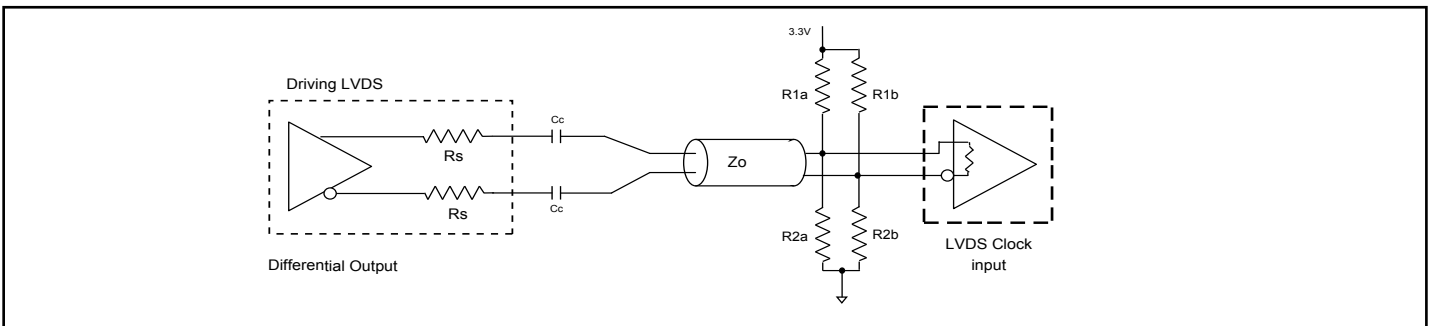
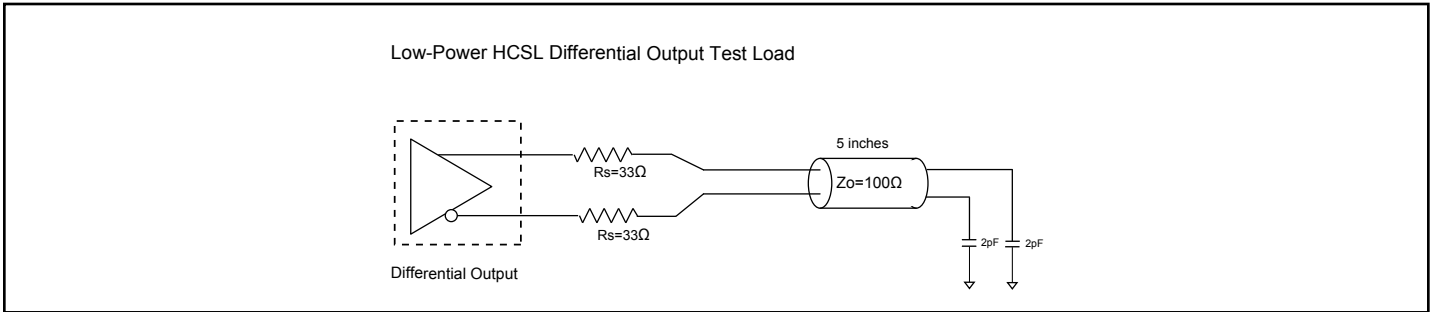
| Bit | Control Function | Description | Type | Power Up Condition | 0 | 1 |
|-----|------------------|-------------|------|--------------------|--|---|
| 7 | DTYPE1 | Device type | R | 0 | '00' = CG, '01' = ZDB, '10' = Reserve, '11' = ZDB | |
| 6 | DTYPE0 | | R | 1 | | |
| 5 | DID5 | Device ID | R | 0 | 000010 binary, 02Hex | |
| 4 | DID4 | | R | 0 | | |
| 3 | DID3 | | R | 0 | | |
| 2 | DID2 | | R | 0 | | |
| 1 | DID1 | | R | 1 | | |
| 0 | DID0 | | R | 0 | | |

Byte 7: Byte Count Register

| Bit | Control Function | Description | Type | Power Up Condition | 0 | 1 |
|-----|------------------|------------------------|------|--------------------|--|---|
| 7 | Reserved | | | 0 | | |
| 6 | Reserved | | | 0 | | |
| 5 | Reserved | | | 0 | | |
| 4 | BC4 | Byte count programming | RW | 0 | Writing to this register will configure how many bytes will be read back, default is 8 bytes | |
| 3 | BC3 | | RW | 1 | | |
| 2 | BC2 | | RW | 0 | | |
| 1 | BC1 | | RW | 0 | | |
| 0 | BC0 | | RW | 0 | | |

Plots
100MHz HCSL Clock





Alternate Differential Output Terminations

| Component | Receiver with termination | Receiver without termination | Unit |
|------------------|---------------------------|------------------------------|---------------|
| R_{1a}, R_{1b} | 10,000 | 140 | Ω |
| R_{2a}, R_{2b} | 5,600 | 75 | Ω |
| C_C | 0.1 | 0.1 | μF |
| V_{CM} | 1.2 | 1.2 | V |

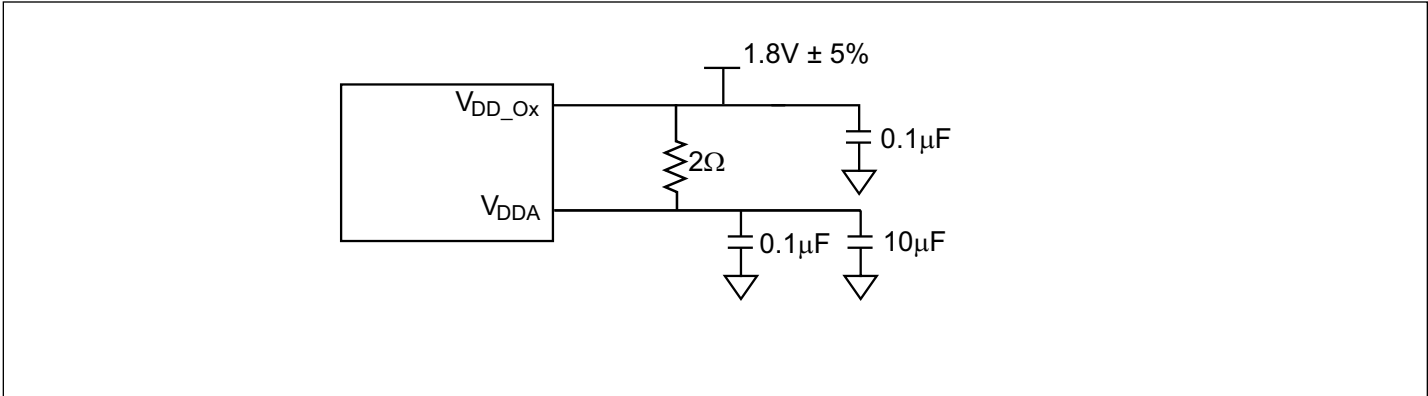
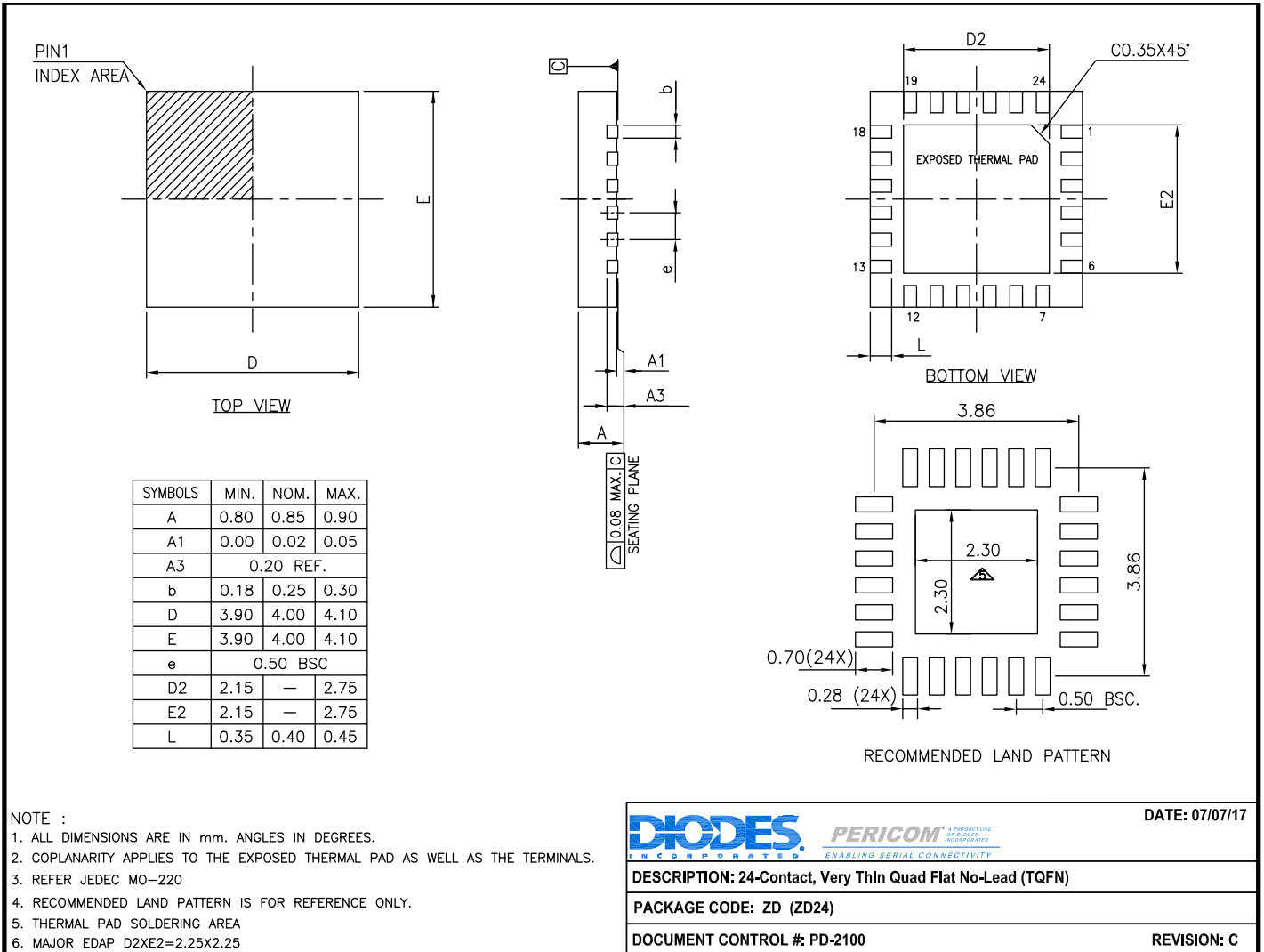


Figure 3. Power Supply Filter

Packaging Mechanical: 24-Pin TQFN (ZD)



17-0533

Ordering Information⁽¹⁻³⁾

| Ordering Code | Package Code | Package Description | Operating Temperature |
|-----------------|--------------|---|-----------------------|
| PI6CB18200ZDIE | ZD | 24-Pin, Pb-free & Green (TQFN) | Industrial |
| PI6CB18200ZDIEX | ZD | 24-Pin, Pb-free & Green (TQFN), Tape & Reel | Industrial |

Notes:

- Thermal characteristics can be found on the company web site at www.diodes.com/packaging/
- E = Pb-free and Green
- Adding an X suffix = Tape/Reel

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